AD-88 Series
One-Component Epoxy Adhesives

Applications

Suitable for high-temperature bonding applications in electronic and electrical equipment.

Specifications

			AD-88	AD-88H
Color	:		Black	Black
Viscosity	:	@30°C	47,000 - 49,000	Paste
Specific Gravity	:		1.5 - 1.6	1.5 - 1.7
Solids Content	:		100 %	
Curing Conditions	:		100°C x 60 min 120°C x 30 min 150°C x 10 min	
Hardness	:	Shore D	84 - 90	
Recommended Operating Temperature	:		-40 to 220 °C	
Bond Strength	:		2.3 - 2.8 KP/mm²	
Flexural Strength	:		120 - 140 MPa	
Compressive Strength	:		115 - 125 MPa	
Water Absorption	:	@23°C, 24 h	5 - 15 mg	
	:	@100°C, 0.5 h	20 - 30 mg	
Heat Deflection Temperature	:		125 °C	
Coefficient of Linear Thermal Expansion	:		(60 - 65) x 10^{-6}/°C	
Shelf Life	:	@10°C	4 months	
	:	@0°C	8 months	

※ **Store the product at the recommended temperature. Before use, allow the unopened container to reach room temperature before opening** to prevent moisture from condensing in the product and affecting its quality.

※ After opening, if any product remains and will not be used for an extended period, reseal the container and return it to low-temperature storage. Keep away from high-temperature heat sources such as ovens and solder pots.

傑 地 有 限 公 司
JASDI CHEMICALS CO., LTD.
Website:www.jasdi.com.tw
E-mail: jasdikao@ms21.hinet.com.tw

台 北 Taipei :+886-2-26008672
台 中 Taichung :+886-4-25685848
東 莞 Dongguan :+86-769-88188707
上 海 Shanghai :+86-21-58356975